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Anderson et al.

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## [54] TRANSPARENT SUBSTRATE PROVIDED WITH A THIN-FILM COATING

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580, 585, 586, 588

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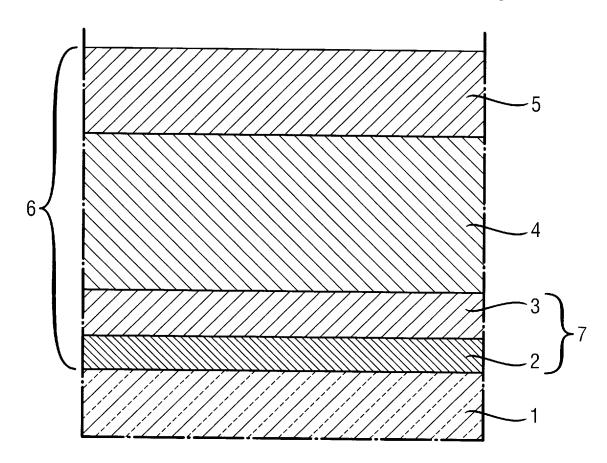
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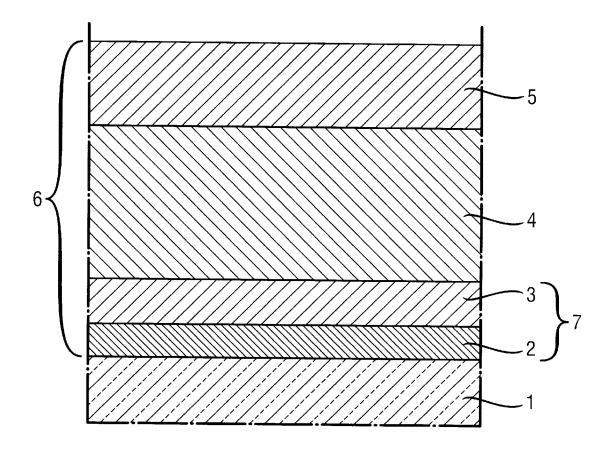
#### [57] ABSTRACT

The subject of the invention is a transparent substrate (1), in particular a glass substrate, including a coating (6) of one or more thin films on at least one of its faces, comprising at least one A film containing an aluminum fluoride or aluminum oxyfluoride  $Al_xO_vF_z$ , with  $y \ge 0$ .

#### 14 Claims, 1 Drawing Sheet







Hig: 1



#### TRANSPARENT SUBSTRATE PROVIDED WITH A THIN-FILM COATING

#### BACKGROUND OF THE INVENTION

The invention relates to transparent substrates, in particular glass substrates, which are provided with coatings composed of one or more thin films which have interferencescale thicknesses and are designed to give specific properties to the substrates which bear them, for example, thermal, optical or electrical properties.

The invention also relates to the use of these coated substrates, in particular to produce glazing, as well as to the method of obtaining them.

The coatings mentioned above therefore consist of stacks of films with varied chemical composition and properties. They are most often dielectric films, for example of the metal oxide or nitride or silicon oxide type, and/or conductive films, for example films of metal such as silver or doped metal oxide. For optical reasons, in many cases these coatings include films whose refractive index is to be 20 carefully selected.

A type of coating, referred to as an anti-reflection coating, is thus known which usually consists of an alternating sequence of dielectric films with high and low refractive indices. Deposited on a transparent substrate, a coating of this type has the function of reducing the light reflection factor of this substrate, and therefore of increasing its light transmission factor. A substrate coated in this way will thus have an increase in its transmitted-light/reflected-light ratio, which improves the visibility of objects placed behind it. It can then be used in many applications, for example to protect a picture illuminated by a light placed behind the observer, or to constitute or form part of a shop window, in order more clearly to discern what is contained in the window, even when the interior lighting is low compared to the exterior lighting, or alternatively in interior furniture or as an anti-glare screen arranged in front of computer screens.

The performance of an anti-reflection coating can be measured or evaluated on the basis of various criteria. Firstly, of course, are the optical criteria. It may be considered that a "good" anti-reflection coating should be able to lower the light reflection factor of a standard clear glass substrate to a given value, for example 2%, or 1% and less. Similarly, it may be important for this coating to keep a 45 satisfactory colorimetry for the substrate, in particular in reflection, for example an extremely neutral one which is very close to that of the bare substrate. Other criteria may also be taken into account depending on the application which is envisaged, in particular the chemical and/or 50 to silicon oxide deposition, in which use is made of a mechanical durability of the coating, the cost of the materials which are used, the manufacturing time or the techniques to be used for manufacturing it.

In this type of anti-reflection stack, as in others, it must therefore be possible to manufacture films of material with low refractive index, for example with an index of less than 1.65

Various materials currently meet this criterion. Mention may be made of magnesium fluoride MgF<sub>2</sub>, with an index of about 1.38, which can be deposited in the form of a thin film 60 by a technique of the vacuum evaporation type. This is a technique which is reliable for deposits on small surfaces, for example surfaces of spectacles or lenses, but becomes expensive and complicated when deposition on larger surfaces is involved, for example on glazing.

Silicon oxide SiO<sub>2</sub>, with a refractive index of about 1.45, now also be mentioned. This material can be denosited using

a cathodic sputtering technique, which technique is entirely suitable for deposits on large surfaces of the glazing type. However, it is not very easy to deposit SiO<sub>2</sub> by reactive sputtering in the presence of oxygen. Further to the fact that it is necessary to dope the silicon target with another element, in particular boron or aluminium, the deposition rate of the SiO<sub>2</sub> film when using this technique is low, and the deposition conditions are sometimes difficult to stabilize and control.

#### SUMMARY OF THE INVENTION

The object of the invention is therefore to overcome these drawbacks, by seeking a novel type of material with low refractive index, which can be deposited, on an industrial scale, in the form of a high-quality thin film, with a manufacturing method which is satisfactory, in particular in terms of cost, ease of use and/or efficiency.

The subject of the invention is a transparent substrate, in particular a glass substrate, which includes a coating of one or more thin films on at least one of its faces. This coating comprises at least one film containing an aluminium fluoride or an aluminium oxyfluoride  $Al_xO_vF_z$  (with  $y \ge 0$ ) which film will hereafter be denoted, by convention and for the sake of convenience, by the term "A film". This material actually has several advantages, primarily in terms of its manufacturing process: aluminium fluoride or aluminium oxyfluoride can in fact be deposited in a thin film using a vacuum technique of the cathodic sputtering type, optionally magnetic field-enhanced cathodic sputtering.

#### BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is a schematic view of a section of a substrate covered with an anti-reflection stack employing at least one A film according to the invention.

#### DETAILED DESCRIPTION OF THE INVENTION

In contrast to a technique of the thermal evaporation type, the cathodic sputtering technique is of great benefit; it makes it possible to mass-produce complex thin-film stacks by successive deposits on the same production line, and can be adapted to widely varying substrate sizes, in particular large sizes; it is thus entirely appropriate for manufacturing coatings for windows intended for the building or automotive

Furthermore, using a technique of this type for depositing aluminium oxyfluoride does not entail problems: in contrast low-conductivity silicon target which must be doped, a standard metal target made of aluminium is used in this case (the term "standard" target is intended to mean a plane geometrical configuration for the target, as opposed to rotationally cylindrical targets, which may clearly also be used). The A film is then deposited in a reactive atmosphere comprising an oxidizing gas, such as oxygen, and a fluorinated gas, with a standard DC electrical supply. The deposits thus produced are to a great extent reproducible and easy to control. Furthermore, the deposition rate of a film of this type is much higher than that of an SiO<sub>2</sub> film deposited by sputtering, and is high enough to make it fully compatible with the short manufacturing time requirements relevant to mass production of coatings, more particularly for glazing.

Furthermore, the A film manufactured in this way, which is of high quality, is also advantageous in terms of its optical properties nure aluminium ovide Al O has a refractive



index of about 1.65. By introducing fluorine to obtain an oxyfluoride, or even by fully substituting fluorine for oxygen to obtain a fluoride, the index of the film can be reduced in controlled fashion, since the refractive index of the film decreases as its fluorine content increases. By adapting the deposition conditions, and in particular by altering the level of fluorinated gas relative to the oxidizing gas in the cathodic-sputtering deposition atmosphere, an A film with variable fluorine level can be obtained, up to complete fluorine saturation in the absence of oxidizing gas, the index 10 of which film can be set very accurately within a wide range of values. The index of the A film is thus chosen to be less than 1.63, and is preferably chosen between 1.60 and 1.32, in particular between 1.35 and 1.45. This flexibility in terms of the choice of refractive index makes the A film very 15 beneficial because it can be adapted as a function of the optical role which it is intended to fulfill within a given thin-film stack. In the formula  $Al_xO_vF_z$ , the equation: 3x=2y+z is satisfied, it being understood that "y" is allowed to be greater than or equal to zero.

The level of fluorine in the A film can thus be advantageously chosen so that the F/Al atomic ratio in the film is between 0.1 and 3.0, in particular between 0.10 and 2.50, preferably between 0.16 and 2.45. Similarly, the O/F atomic ratio can be adjusted so that it is between 0 and 10, in  $^{25}$ particular between 0.1 and 10, preferably between 0.15 and

Various considerations may also lead to elements other than oxygen, fluorine and aluminium being introduced into the A film. This may, in particular, involve an oxide or a mixture of oxides, preferably belonging to the following group: silicon oxide SiO<sub>2</sub>, tin oxide SnO<sub>2</sub>, nickel oxide NiO.

Since all these oxides have an index of at most 1.9, adding them to the film may be an additional means of adjusting the index of the film, as a function of its fluorine content, without increasing it in undesirable proportions. They may furthermore have a good influence on the mechanical or chemical durability of the film, which may prove important when the A film is the outermost film in the film stack of which it forms part, and therefore, in fact, when it may be exposed directly to attack such as mechanical abrasion, exposure to corrosive chemical products or unfavourable weather conditions.

in the chemical durability of the A film, in particular an increase in its resistance to moisture. The A film advantageously comprises a mixture of aluminium fluoride or aluminium oxyfluoride/silicon oxide. In this case, it is and 1.00, preferably between 0.06 and 0.10; an O/F atomic ratio of between 0.2 and 10, and preferably between 0.25 and 8.70, and an F/Al atomic ratio of between 0.1 and 2.5, preferably between 0.18 and 2.40.

According to a first, non-limiting embodiment, the A film 55 forms part of a thin-film stack with reflection properties in the infrared and/or in the solar radiation range, in particular stacks comprising at least one metal film, of the silver type, arranged between two dielectric coatings. In view of its low refractive index, it is particularly well-suited for acting as an intermediate film with a lower index than the substrate, and arranged between the substrate and the stack, as described in patent EP-0,745,569.

According to another non-limiting embodiment of the invention, the A film forms part of an anti-reflection coating 65 including an alternating sequence of dielectric films with high and low reflective indices at least one of the low index

films in the stack consisting of an A film. This may be the last film in the anti-reflection coating, or alternatively all the low-index films therein.

In the context of the invention, the term "low index" is intended to mean refractive indices of between 1.65 and 1.32, in particular less than 1.60, and the term "high index" is intended to mean refractive indices of at least 1.60, in particular between 1.9 and 2.45.

Using films of the A type as low-index films in an anti-reflection coating is actually quite advantageous: it may be substituted for the silica films conventionally used in this type of coating. It is then possible to make two different choices: either the A film has a fluorine level selected so that it has an index close to that of silica, that is to say close to 1.45 In this case, one material has been "replaced" by another material which is easier to deposit by cathodic sputtering but is optically equivalent in the anti-reflection stack. Alternatively, the A film is chosen so that it has a substantially lower index than silica, in particular less than 1.40, for example of the order of 1.37 to 1.38. In this case, it allows a much wider choice of possible high-index materials. Considering in broad outline the method of evaluating the performance of an anti-reflection coating, it can be stated that the capacity of such a coating to lower the light reflection factor value of the substrate bearing it is correlated with the difference between the refractive indices of the high- and low-index films which form the stack, and more particularly with the difference between the indices of the last two high- and low-index films therein. It has to date been conventional to combine a high-index film of the titanium oxide type, that is to say one having an index of at least 2.25, with a low-index silica film. As soon as a material with lower index becomes preferable to silica, it is acceptable for the high-index films used to be films of a material with relatively lower index, for example simply at least 1.9 to 2.2, without sacrificing the optical performance of the anti-reflection

Thus, the anti-reflection coating which includes at least one film of type A as a low-index film, may use high-index 40 films, of actually very high index, of at least 2.25 such as niobium oxide, Nb<sub>2</sub>O<sub>5</sub>, zirconium oxide ZrO<sub>2</sub>, titanium oxide TiO<sub>2</sub>, bismuth oxide Bi<sub>2</sub>O<sub>3</sub> or cerium oxide CeO<sub>2</sub>. But it is nevertheless possible to employ high-index films with slightly lower index, in particular of the order of 1.90 to Alow silicon oxide content thus provides an improvement 45 2.20, for example tungsten oxide WO<sub>3</sub>, tin oxide SnO<sub>2</sub>, zinc oxide ZnO, aluminium nitride AlN, silicon nitride Si<sub>3</sub>N<sub>4</sub> or tantalum oxide Ta<sub>2</sub>O<sub>5</sub>. Even with this type of material, a refractive index difference of at least 0.5, in particular about 0.8, may actually be maintained between high- and lowpreferable to choose an Si/Al atomic ratio of between 0.05 50 index films. It may also be industrially beneficial, for example, to use WO<sub>3</sub> or SnO<sub>2</sub> rather than Nb<sub>2</sub>O<sub>5</sub> or TiO<sub>2</sub> as a high-index film, in particular because the former films have a much greater cathodic-sputtering deposition rate than

> Furthermore, the use in anti-reflection stacks of A films having a lower index than silica presents two additional advantages in terms of optics, and more particularly in terms of the calorimetric appearance in reflection: the residual colour in reflection of the coated substrate is made more neutral, and the variations in colour as a function of the angle of incidence at which the coated substrate is observed are found to be much less.

An anti-reflection coating according to the invention, comprising at least one A film, may comprise only two successive sequences of high- and low-index films. Four films may in fact be sufficient to obtain a remarkable anti-reflection effect



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Examples of an anti-reflection coating having this configuration may thus be stacks of the type:

SnO<sub>2</sub>/SiO<sub>2</sub>/Nb<sub>2</sub>O<sub>5</sub>/A film or

SnO<sub>2</sub>/A film/Nb<sub>2</sub>O<sub>5</sub>/A film.

The  $Nb_2O_5$  films may also be advantageously replaced by 5  $SnO_2$ ,  $WO_3$ ,  $Bi_2O_3$  or  $TiO_2$  films.

According to another configuration, the anti-reflection stack may comprise not two but three sequences of high- and low-index films. The anti-reflection effect may then be even greater and combined with a more neutral residual colour in reflection, but manufacturing the stack takes a little longer and is slightly more expensive.

According to another configuration, the first sequence of high- and low-index films in the anti-reflection coating (the term "first sequence" is used to denote the sequence closest to the surface of the substrate bearing the coating), is substituted by a single film having an intermediate refractive index of between 1.65 and 1.80. An intermediate-index film of this type has an optical effect similar to that of a high-index film/low-index film sequence and has the advantage of reducing the overall number of films in the stack.

According to yet another configuration, at least one of the so-called high-index films in the anti-reflection stack, and in particular the film in the second sequence, may be a high-index "overall" film, the term "overall" indicating that it is in fact a superposition of high-index films, in particular two 25 or three. In terms of optics, this "overall" film broadly fulfils the role of a single film with an index intermediate between the refractive indices of the various films which form it.

It is thus possible to have stacks of the type: glass/SnO<sub>2</sub>/A film/Bi<sub>2</sub>O<sub>3</sub>/SnO<sub>2</sub>/Bi<sub>2</sub>O<sub>3</sub>/A film or glass/SnO<sub>2</sub>/A film/Nb<sub>2</sub>O<sub>5</sub>/SnO<sub>2</sub>/A film.

The anti-reflection stack can thus be given an additional anti-static function by incorporating a film of a conductive material in the stack, in particular a material of the doped metal oxide type, such as tin-doped indium oxide ITO.

Each of the faces of the substrate is preferably covered with an anti-reflection stack of this type, in order to obtain the maximum anti-reflection effect.

With the anti-reflection stacks described above, a reduction in the light reflection factor values  $R_L$  of the substrates 40 is achieved to values of at most 2%, in particular at most 1% or at most 0.5%. This provides an aesthetic and pleasant calorimetric appearance in reflection, in particular subtle blue or blue-green tints, which is expressed in the (L\*, a\*, b\*) colorimetry system by negative a\* and b\* values of at 45 most 3.5 in absolute value for a\* and at most 1.5 in absolute value for b\*.

A further subject of the invention is coatings which, further to at least one film of type A, comprise at least one film with given thermal properties, in particular with a sun-protection property or with low emissivity, of the metal type, such as silver or aluminium, or of the doped metal oxide type, for example fluorine-doped tin oxide SnO<sub>2</sub>:F or tin-doped indium oxide ITO.

A further subject of the invention is glazing incorporating 55 the coated substrates, irrespective of whether they are monolithic, laminated, or multiple with one or more intermediate gas layers.

This glazing can be used either as interior or exterior windows for buildings or as glass for protecting an object, 60 such as a picture, shop-window display, glazed furniture such as a counter or refrigerated display window, etc., or as motor-vehicle windows such as a laminated windscreen, as mirrors, anti-glare screens for computers, or decorative glass.

A further subject of the invention is the method for

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substrates, with coatings containing A films. One method consists in depositing all the films, successively one after the other, using the vacuum technique, in particular by magnetic field-enhanced cathodic sputtering. It is thus possible to deposit the oxide films by reactive sputtering of the metal in question in the presence of oxygen, the nitride films in the presence of nitrogen, and the A films by reactive sputtering from a target containing aluminium, in the presence of fluorinated gas in order to obtain a fluoride, and in the presence of fluorinated gas and oxidizing gas, such as oxygen, in order to obtain an oxyfluoride.

It is not, however, ruled out that some of the films in the stack, with the exception of the A films, be deposited by another technique employing a vacuum, or by a technique of the pyrolysis type, in particular the first film in the stack (or the first two) directly in contact with the substrate bearing the coating, when this substrate is made of glass.

The invention places no limitation in terms of the nature of the transparent substrate bearing the coating, which may therefore be made of glass or plastic.

The advantageous characteristics and details of the invention will presently emerge from the following non-limiting examples, with reference to FIG. 1.

This figure very schematically represents a section of a substrate covered with an anti-reflection stack employing at least one A film according to the invention (for the sake of clarity, the relative proportions of the substrate and film thicknesses have not been respected). In fact, each of the faces of the substrate is provided with an identical stack, but 30 for simplicity only a single stack has been represented. Throughout the following examples, a coating was used on each of the faces of the substrate.

It should be pointed out that, in these examples, the successive thin-film deposits were made by magnetic field-35 enhanced reactive cathodic sputtering.

The substrates on which the anti-reflection coatings are deposited are clear silica-soda-lime substrates of the Planilux type marketed by Saint-Gobain Vitrage, with a thickness of 3 to 6 mm, in particular 4 mm.

FIG. 1 represents the glass substrate 1 which, according to a first embodiment, is coated on its two faces with a four-film stack 6 including an alternating sequence of high-index thin films 2, 4 and low-index thin films 3, 5.

A first series of examples was carried out with niobium oxide in film 4 and tin oxide in film 2 for the high-index films:

#### EXAMPLE 1

further to at least one film of type A, comprise at least one film with given thermal properties, in particular with a 50 following sequence (the geometrical thicknesses of the sun-protection property or with low emissivity, of the metal films, in nanometers, are indicated under each of them):

Films 2, 3 and 4 are respectively obtained from tin, doped-silicon and niobium targets in the presence of oxygen.

The A film, with formula  $Al_xO_yF_z$  is obtained from an aluminium target, in the presence of oxygen and  $CF_4$  (other fluorinated gases may be used in combination with or in place of  $CF_4$ , for example  $C_2F_4$ ). The  $CF_4$  level is adjusted to obtain a film with a refractive index of about 1.37. The light reflection factor  $R_L$ , based on the  $D_{65}$  illuminant, measured on the coated substrate is



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